MODIS Hardware Development Status

12 October, 1994

T. Pagano







MODIS Technical Status Topics



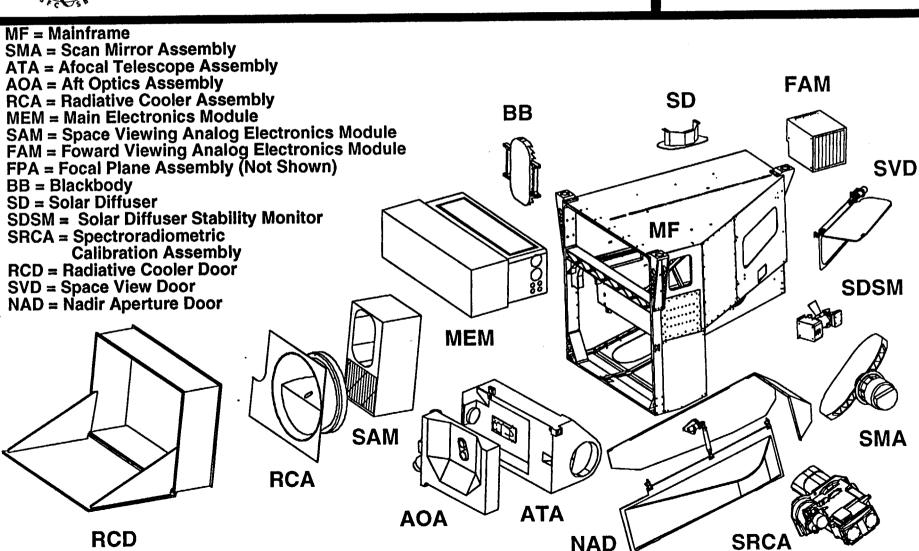
- Engineering Model (EM) Subassembly Status
 - Mainframe
 - Scan Mirror
 - Telescope
 - Aft Optics Assembly
 - Radiative Cooler
 - Focal Plane Assemblies
 - Electronics Modules
 - Blackbody
 - Performance Highlights
 - Hardware Development Video

EM SUBASSEMBLY STATUS



EXPLODED VIEW HIGHLIGHTS MAJOR SUBASSEMBLIES







Subassembly Status



MF = Mainframe SMA = Scan Mirror Assembly ATA = Afocal Telescope Assembly AOA = Aft Optics Assembly RCA = Radiative Cooler Assembly MEM = Main Electronics Module SAM = Space Viewing Analog Electronics Module FAM = Foward Viewing Analog Electronics Module FPA = Focal Plane Assemblies BB = On-Board Blackbody	Complete Complete Complete Complete Complete 80% In Test In Test Complete 50%
SD = Solar Diffuser SDSM = Solar Diffuser Stability Monitor SRCA = Spectroradiometric Calibration Assembly RCD = Radiative Cooler Door SVD = Space View Door NAD = Nadir Aperture Door	Not on EM Not on EM Not on EM Not on EM Not on EM

Mainframe Fabricated and Tested



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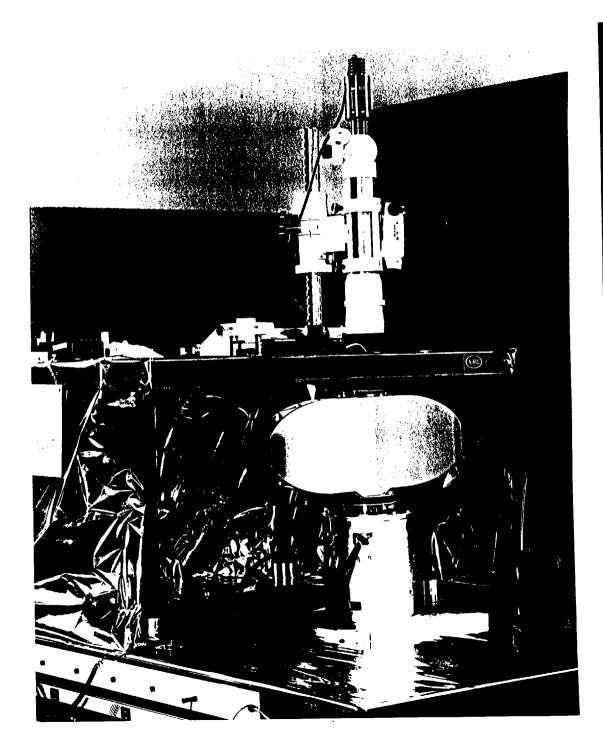


Mass-Loaded Mainframe Test Successful



- Mass-Loaded Mainframe (Structural Model) successfully qualified
 - Full Power Random in X, Y, and Z (5.7 g-rms)
 - Full Power Proof Loads test using Sine Burst
 - 12 g's in X, 9.8 g's in Y and Z
 - Mainframe has higher damping than assumed for structural analysis

Achieved Spec
 Lowest Fundamental Mode 43 Hz 35 Hz





Scan Mirror Assembly Complete



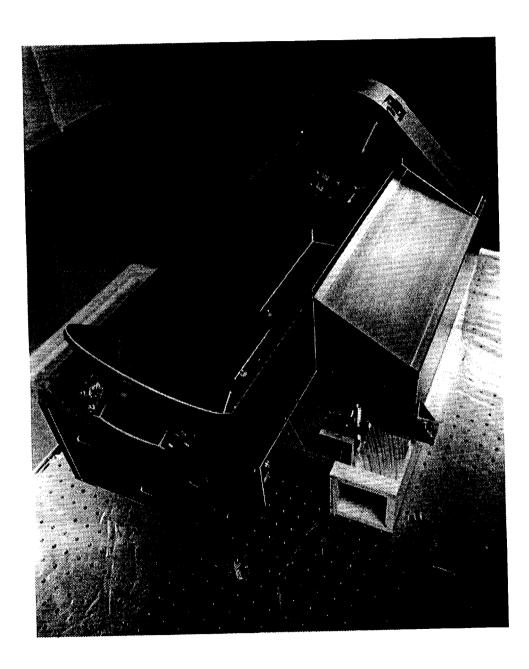


EM Scan Mirror Assembly Performance Results



- Scan mirror integrated to motor/encoder
- Scan mirror aligned to rotational axis of motor
- Scan mirror assembly ready for integration
- Mirror temperature monitor breadboard unit testing complete
- Bearing life test at 10 Million cycles (57 Million Required)

	<u>Measured</u>	<u>Spec</u>
Mirror rotational error to motor/encoder	2 arcsec	< 10 arcsec
Mirror parallelism	< 10 arcsec	< 36 arcsec
Motor/encoder positional repeatability	< 0.5 μ rad	< 10 μr rms





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EM Afocal Telescope Assembly Complete





Afocal Telescope Assembly Complete



- Mirrors prealigned on alignment fixture
- Mirrors installed & Aligned on Afocal Telescope Bench
- ATA Ready for system integration with Aft-Optics Assembly

	<u>Measured</u>	<u>Spec</u>
 Abberation 	1-wave @ 632.8nm	3-waves
Boresight Error	2 pixels	1 pixel
 Magnification 	3.984x (0.4% Error)	4x ± 0.1%

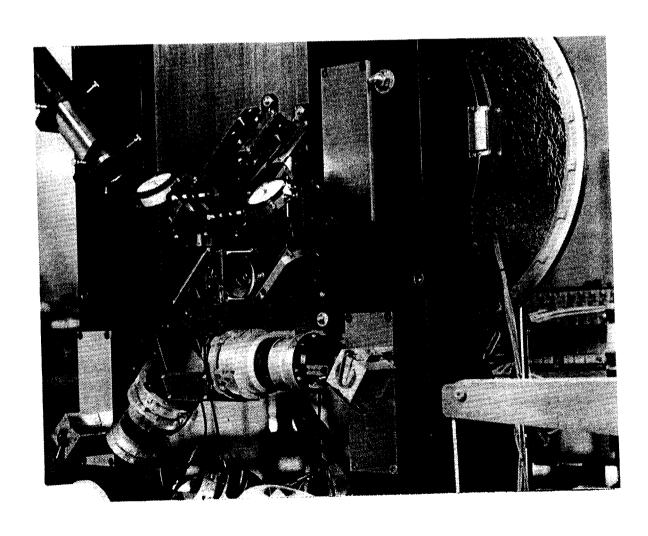
Boresight and Magnification errors easily correctable for PF



All Objectives Complete & Integrated to AOP



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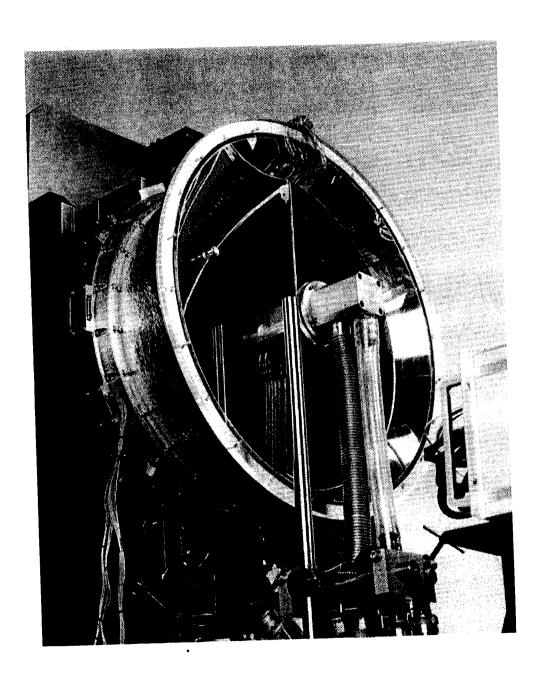
All Objective Assemblies Complete



- Objective lenses mounted in lens cells
- Pre-alignment (boresight, EFL, distortion) in optics laboratory
- Objectives integrated onto Aft-Optics Platform
- Residual Performance After Alignment:

	<u>EFL E</u>	EFL Error		<u> Blur</u>
	<u>Measured</u>	<u>Spec</u>	<u>Measured</u>	<u>Spec</u>
VIS	- 0.13%	0.3%	45 μ m	100 μ m
NIR	+0.25%	0.3%	44 μ m	100 μm
SMWIR	+1.4%	0.3%	59μm	100 μm
LWIR	-1.1%	0.3%	50 μ m	100 μ m

• EFL Errors due to integration tooling deficiencies; correctable for PF





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Radiative Cooler Complete & Integrated to AOP





Radiative Cooler Meets Performance Objectives



- Passive Radiative Cooler assembly complete
- SWIR/MWIR and LWIR FPAs installed
- Cooler successfully vibrated to acceptance levels
- Thermal vacuum testing shows acceptable performance
- Cooler integrated to AOP; Bench Test Cooling to ≤ 83K successful

	Predicted	<u>Measured</u>	In-Flight	<u>Spec</u>
Lowest Achievable Temperature	74.7K	73.3K	73.9K	N/A
Nominal Load Temperature	81.2K	80.5K	81. 0 K	85.0K

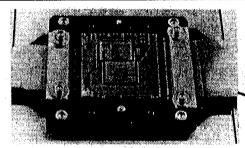


ALL ENGINEERING MODEL FOCAL PLANES DELIVERED

HUGHES

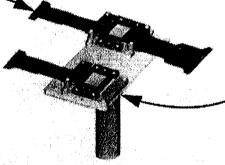
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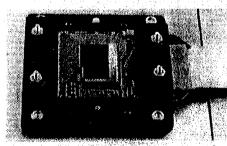
EM LONGWAVE IR FPA



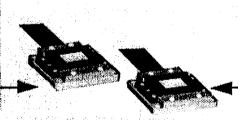




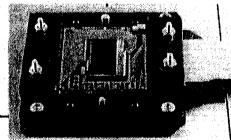
SHORT/MID WAVE



EM VISIBLE FPA



AMBIENT FPAS



EM NEAR IR FPA



FPA TEST RESULTS SUPPORT CHALLENGING REQUIREMENTS

HUGHES

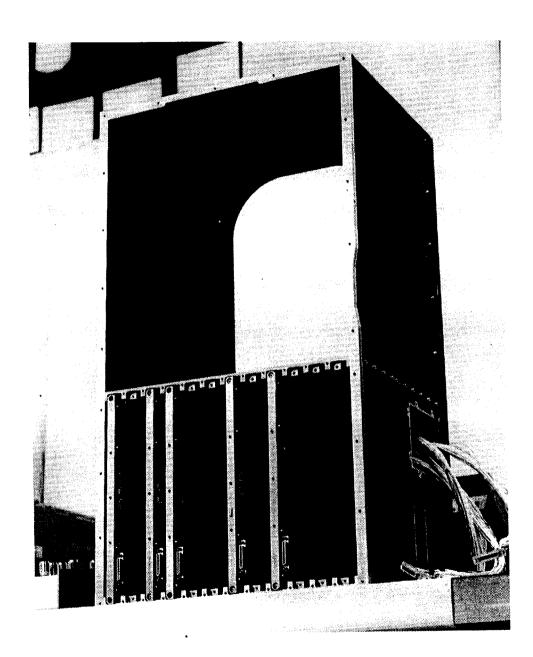
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	1		Engineeri		
Key Parameter	Requirement	VIS	NIR	S/MWIR	LWIR
Non- Linearity	PV: ±5%, PC: ±10%	±1%	±4%	±3%	±2/±8%
Responsivity Stability	±0.05%	±0.02%	±0.04%	±0.03%	in Test
Temperature insensitivity	V, N: 0.25% per ±1K S/M,L: 3% per ±0.2K	0.05%	In Test	<0.5	<1%
Saturation Recovery	1 frame, 0.5%	0.66%	In Test	<1.0%	In Test
Interband Crosstalk	0.3%	TBT	TBT	TBT	ТВТ
Spatial Uniformity	±15% @ 80%	±1.5%	±3%	±1%	±7.2%
Spectral Uniformity	±15% @ 50%	±4%	±3%	±1.1%	±2.5%
Power Dissipation	CFPA: <58mW @ 85K	<15mW	<26mW	17mW	In Test
Polarization Insensitivity	< 0.001	<0.001	<0.001	N/A	N/A
Total Dose, Rad(SI)	5K	30K *	30K *	20K *	20K

FPA Specification #151780

TBT - To Be Tested

* Protoflight Data





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SAM Complete and In Test (Redundant Boards Not in EM Unit)

• Through Temperature Tests





SAM Completes Initial Ambient Tests



- Space Viewing Analog Module Module for PV Bands
- Assembly, integration and checkout complete
- Performance compatible with specifications
- Automated test set incomplete; test performed using manual test gear

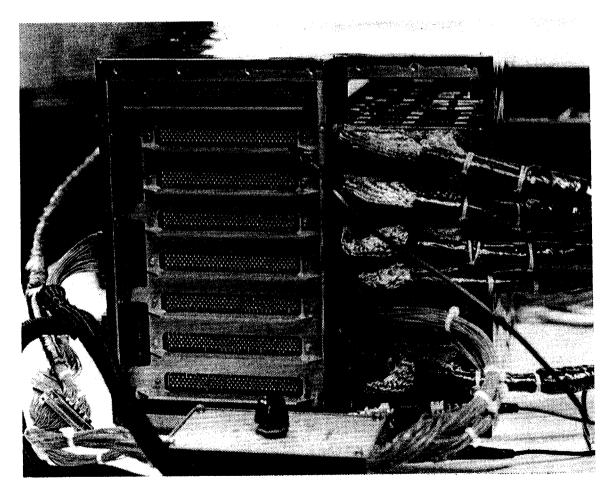
	<u>Measured</u>	<u>Spec</u>
Noise	< 0.6 LSB	< 0.6 LSB
Integral NonLinearity	20 b p-p	8 b p-p
Crosstalk	< 0.03%*, 0.4%	≤ 0.03%
Transient Response	< 0.15%	≤ 0.15%

^{*} VIS, NIR, LWIR; Bands 1, 2, and SWIR at 0.4%



FAM In Test



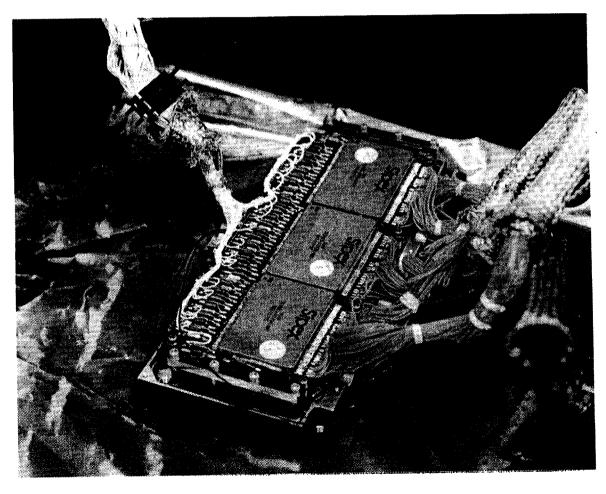


• In Temperature Tests



CLAM Ready for Housing





• Now in Housing in Temperature Tests with FAM



SAM Completes Temperature Tests



- Space Viewing Analog Module for PV Bands
- Assembly, integration and checkout complete
- Performance compatible with specifications
- Automated test set incomplete; test performed using manual test gear

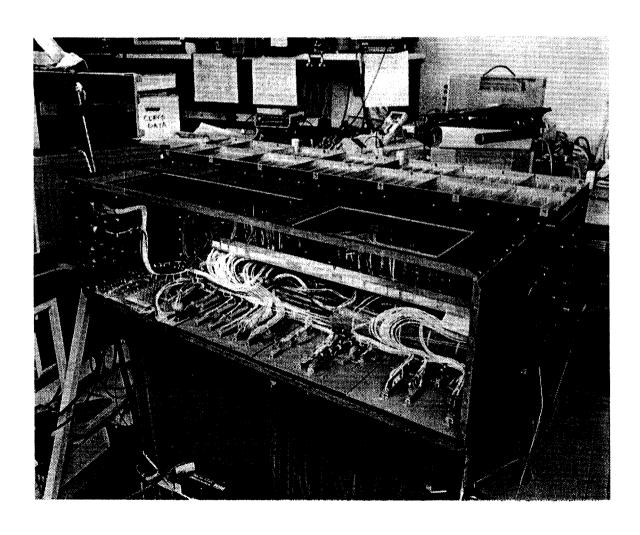
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Transient Response	< 0.15%	≤ 0.15%

^{*} VIS, NIR, LWIR; Bands 1, 2, and SWIR at 0.4%



MEM Nearing Completion







MEM Nearing Completion



- All EM MEM Subassemblies Complete and Tested
- MEM Integration Status:

=	DRAWING	5	6	7 (MEM Integ.	8
	NUMBER	(Assy Compl.)	(Test Compl.)	& Test)	(Comments)
FIFO Memory	E404834	COMPLETE	COMPLETE	COMPLETE (2)	•
FDDI Processor	E404844	COMPLETE	COMPLETE	COMPLETE	
Single-Board Computer	E404850	COMPLETE	COMPLETE	COMPLETE	
Format Engine	E404856	COMPLETE	COMPLETE	N/A	Final Firmware Not Complete
Format Processor	E404867	COMPLETE	COMPLETE	9/14/94	Software Dev't & Test Continuing
Timing Generator	E404864	COMPLETE	COMPLETE	COMPLETE	Commung Port & Test Commung
TCP Command Interface	E404879	COMPLETE	COMPLETE	N/A	Integrated Into TCP
Analog Telemetry & Command	E404882	COMPLETE	COMPLETE	N/A	Integrated Into TCP
Telemetry & Command Processor	E404871	COMPLETE	COMPLETE	COMPLETE	S/W Integration & Test continuing
Scan Servo Controller	E404885	COMPLETE	COMPLETE	COMPLETE	and a voct continuing
Mechanism Controllers	E404891	COMPLETE	COMPLETE	COMPLETE	S/W Rev In Work - Hardware OK
Temperature Controllers	E404897	COMPLETE	COMPLETE	COMPLETE	TIAI WATER OR
Calibrator Controllers 1	E404903	COMPLETE	Nov-94	N/A	Not Required For EM
Calibrator Controllers 2	E404907	COMPLETE	Nov-94		Not Required For EM
Power Supply (HAC-IEG)		COMPLETE	COMPLETE	COMPLETE	Trock flore and a first CIVI
Chassis	E404815	COMPLETE	COMPLETE	COMPLETE	Significant Card & Backplane
Wire Wrap Backplane	E404803	COMPLETE	COMPLETE	COMPLETE	Stiffening Added
Wiring Assembly	E404814	COMPLETE	COMPLETE	COMPLETE	Callering Added

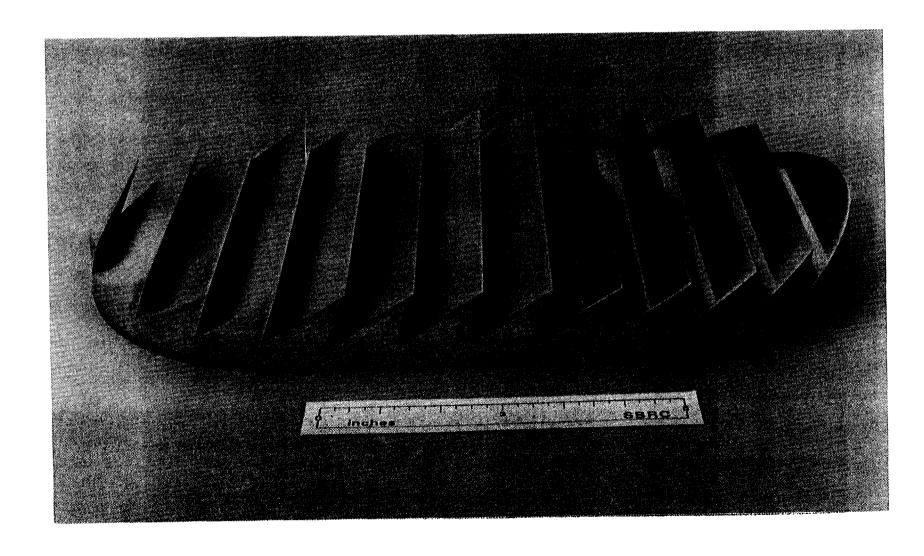
MEM Test Set complete



OBC BB Polishing in Progress



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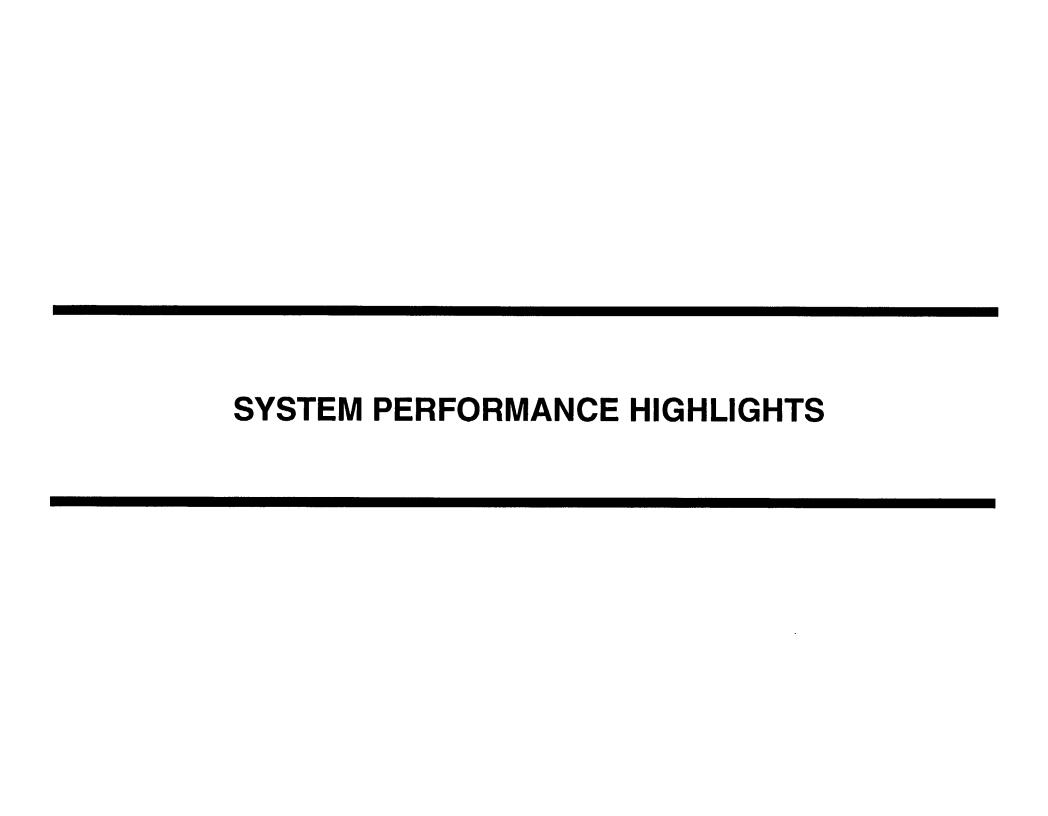




Blackbody Nearing Completion



- Hand polishing nearing completion
- Anodization parameters being defined
- · Heater, flex circuit, and flexible cable drawings released
- · Third draft of test plan reviewed and approved by systems engineering
- Incorporating plan into section 4 of spec
- Delivery to plan date anticipated





Mass, Power, & Data Rate Stable



- Mass down 6.9 kg since PDR!
- Measured power lower than previously calculated
- Data rate unchanged

	Predicted	Spec	Margin	%Actuals
• Mass	228.3 kg	250 kg	21.7 kg	59.5%
• Power	160.8 W	225 W	64.2 W	82.8%
Data Rate	10.6 Mbps	10.8 Mbps	0.2 Mbps	0%

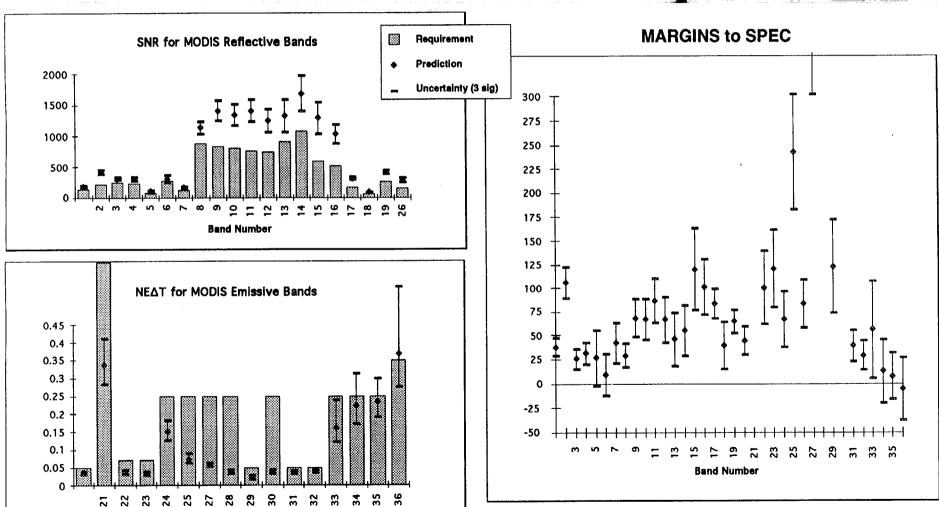
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Band Number

No Change to PFM SNR/NE∆T Predictions



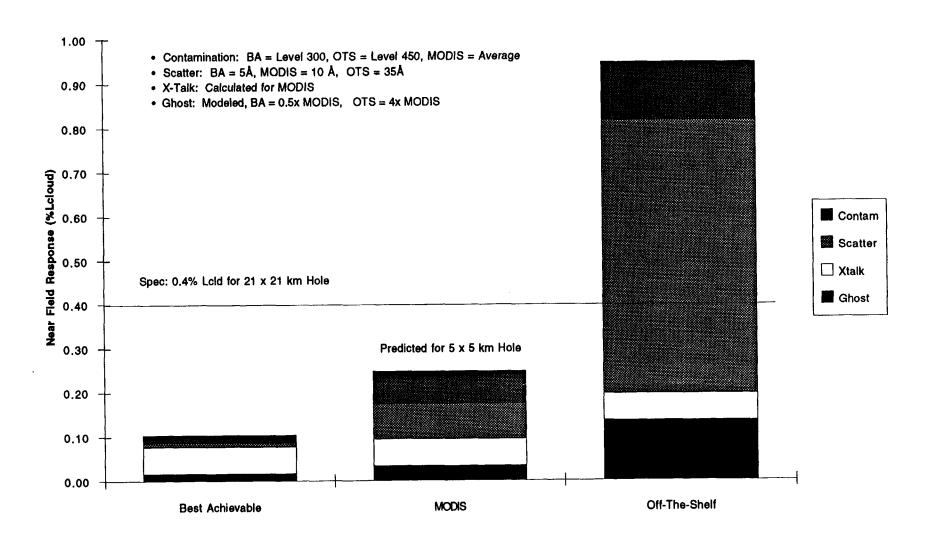


- Includes PF Measurements for PC Detectors
- Optics/Detector Data from EM Measurements



MODIS Near Field Response Approaches Technology Limits







Critical EM Testing Preserved



Test	EM	GSE	Date
 Radiometric Response SNR, Linearity, Dy. Range, Noise 	Ambient T/V	SIS, BCS	1/95
• Spectral Response c.w.l, B.w., o.o.B	Ambient T/V	SPMA	1/95
Spatial Response Registration, IFOV, MTF	Ambient T/V	IAC	1/95
• Transient Response Ghosting, Crosstalk, Scatter	Ambient	SSMA	12/94
 Polarization Response 	Ambient	PSA	11/94



Summary and Conclusions



- All major subassemblies for EM assembled
- Optics/FPAs, Radiative Cooler integrated
- Focus and alignment complete
- Mainframe in house, ready for Scan Mirror mounting
- FAM, SAM, CLAM in test, MEM awaiting S/W completion
- OBC BB polishing in process
- Comprehensive System Testing of EM to Begin in November
- Technical Assessment; On-Track, High Performance Maintained